



# Product Change Notification

**Change Notification #:** 118089 - 00  
**Change Title:** Intel® Server Chassis FC2HAC16W3,  
PCN 118089-00, Product Design,  
Power Supply EMI capacitors removal  
**Date of Publication:** February 8, 2021

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:*</b>	February 8, 2021
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Publication For Historical Records

Ready To Receive Date was originally November 28, 2020. PCN was not published earlier due to no "Sold To" customers at the time of the change.

## Description of Change to the Customer:

The Intel® Server Chassis FC2HAC16W3 will include a newer version of Power Supply AXX1600TCPRPS due to a change in the Power Supply that removes two Electromagnetic Interference (EMI) capacitors. This change has no impact to regulatory certifications or product reliability. If necessary, contact your Intel support representative for additional information on this change.

## Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
FC2HAC16W3	999D40	K25122-008	K25122-009

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
February 8, 2021	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

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